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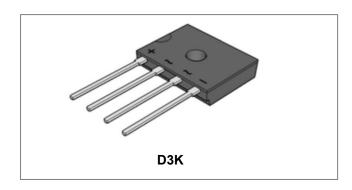








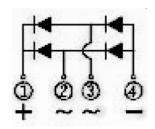
# UG3KB05 THRU UG3KB100 Single-Phase 3.0A Glass Passivated Bridge Rectifier



### **Features**

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- · High surge current capability
- Designed for surface mount application
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

## **Circuit Diagram**



### **Mechanical Data**

• Case: D3K, Molded plastic

Terminals: Plated leads solderable per MIL-STD-202,
 Marked 200.

Method 208

Polarity: as marked on caseMounting Position: Any

Lead Free: For RoHS / Lead Free Version

# Maximum Ratings: @T<sub>A</sub>=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type Number	Symbol	UG3K B05	UG3K B10	UG3K B20	UG3K B40	UG3K B60	UG3K B80	UG3K B100	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>DC</sub>	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>RMS</sub>	35	70	140	280	420	560	700	V
Average Rectified Without heat sink @T <sub>A</sub> = 30°C Output Current With heat sink @T <sub>A</sub> = 140°C		1.5 3.0						Α	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	80					А		

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## **Electrical Characteristics:**

Type Number	Symbol	UG3K B05	UG3K B10	UG3K B20	UG3K B40	UG3K B60	UG3K B80	UG3K B100	Units
Forward Voltage (per element) * @I <sub>F</sub> =3.0A	V <sub>F</sub>	1.1					V		
Peak Reverse Current * @T <sub>A</sub> = 25°C At Rated DC Blocking Voltage * @T <sub>A</sub> = 125°C				μA					
Typical Junction Capacitance(per leg) (Note 1) C <sub>J</sub>		21				pF			

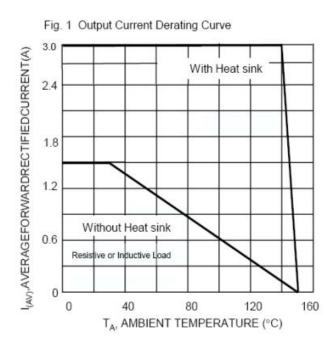
 $<sup>^{\</sup>star}$  Pulse width < 300  $\mu$ s, duty cycle < 2%

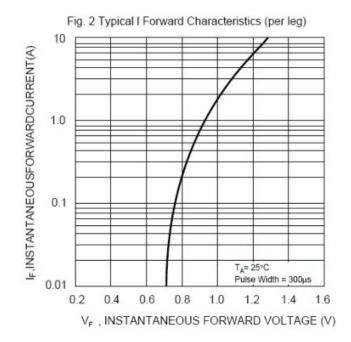
# **Thermal-Mechanical Specifications:**

Type Number	Symbol	UG3K B05	UG3K B10	UG3K B20	UG3K B40	UG3K B60	UG3K B80	UG3K B100	Units
Typical Thermal Resistance (per leg)	R <sub>0JA</sub> R <sub>0JL</sub>	55 15					°C/W		
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150					°C		

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

# **Ratings and Characteristics Curves**



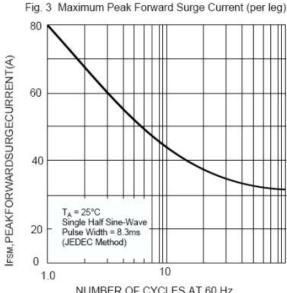


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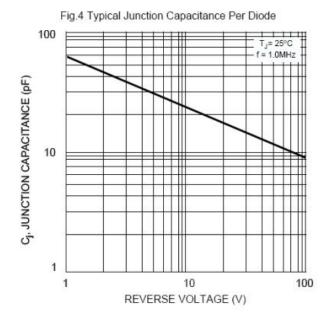


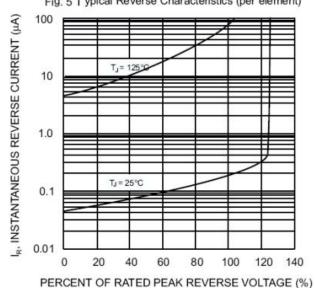






NUMBER OF CYCLES AT 60 Hz Fig. 5 T ypical Reverse Characteristics (per element)





# **Ordering Information**

Device	Package	Plating	Shipping
UG3KB05 THRU UG3KB100	D3K(Pb-Free)	Pure Sn	37pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

# **Marking Diagram**



Where XXXXX is YYWWL

SSG = SSG YY = Year ww = Week = Lot Number UG3KB05 = Type Number

Cautions: Molding resin Epoxy resin UL:94V-0

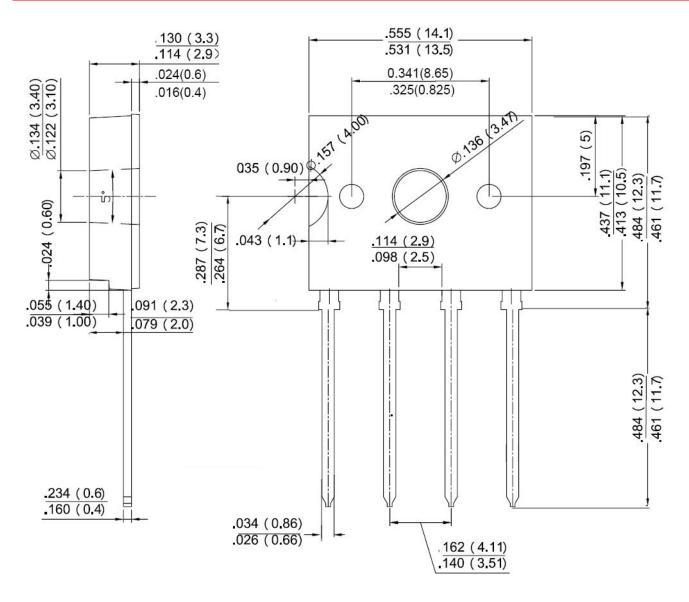
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# **Mechanical Dimensions D3K (Inches/Millimeters)**



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